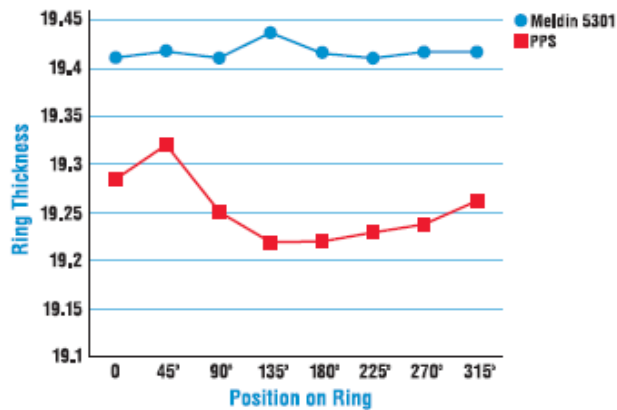
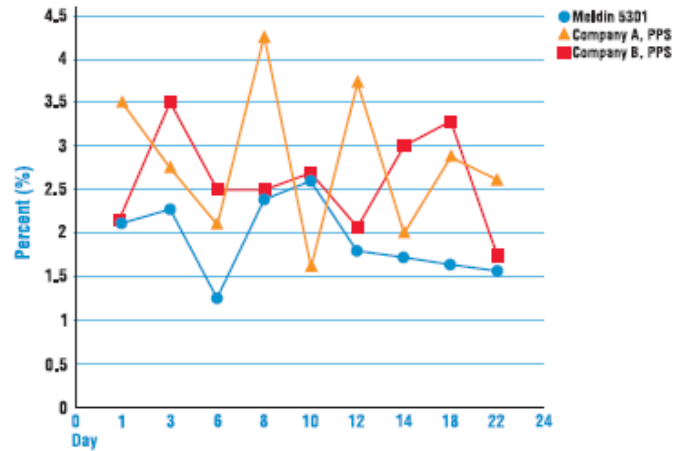


Performance Results – Measured in Actual Wafer Fabs

Ring Profile After 20 Hrs. Oxide Polishing



Average Non-Uniformity



Process Data: Meldin 5301 Vs. PPS Actual Fab Results

Material	Number of Wafers	Average (Removal Rate)	Average (Non Uniformity)	Thickness Removed
Meldin 5301	3263	4288	1.91%	55%
PPS 1	2156	4329	2.44%	70%
PPS 2	2214	4393	2.81%	70%

Relative Break-In Time

Material	Break-In Time (Minutes)
Techtron® PPS	6.2
Meldin® 5301	8.0
Meldin® 5410	7.5
Meldin® 5420	7.6
Meldin® 7001	7.9